MICROCHIP

MX555ABH25M0000

Ultra-Low Jitter 25MHz LVCMOS XO

ClockWorks® FUSION

General Description

The MX555ABH25M0000 is an ultra-low phase jitter XO with LVCMOS output optimized for high line rate applications.

Features

- 25MHz LVCCMOS
- Typical phase noise:
 - 77fs (Integration range: 1.875MHz-5MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

Absolute Maximum Ratings¹

Supply Voltage (VIN)	+4.6V
Lead Temperature (soldering, 10s)	260°C
Case Temperature	115°C
Storage Temperature (T _S) ESD Machine Model	65°C to +125°C
ESD Machine Model	200V
ESD Rating (HBM)	2kV

Operating Ratings²

Supply Voltage (VIN)	+2.375V to $+3.63V$
Ambient Temperature (TA)	40°C to $+85$ °C
Junction Thermal Resistance	
LGA (T _{IA}) Still Air	58°C/W
` JA´	

Electrical Characteristics

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, output terminated with 50 Ohms to VDD/2.3

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
IDD	Supply Current				95	mA
F0	Center Frequency			25		MHz
	Frequency Stability	Note 4			±50	ppm
Øj	Phase Noise	Integration Range (12kHz to 5MHz) Integration Range (1.875MHz to 5MHz)		131 77		fsRMS
Tstart	Start-Up Time				20	ms
TR/TF	Rise/Fall time		100		500	ps
	Duty Cycle		45		55	%
VIH	Input High Voltage	3.3V Operation	2		VDD + 0.3	V
VIL	Input Low Voltage	3.3V Operation	-0.3		0.8	V
VOH	Output High Voltage	LVCMOS output levels	VDD - 0.8			V
VOL	Output Low Voltage	LVCMOS output levels			0.6	V

Notes

- 1. Exceeding the absolute maximum ratings may damage the device.
- 2. The device is not guaranteed to function outside its operating ratings.
- ${\it 3. Guaranteed \ after \ thermal \ equilibrium.}$
- 4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

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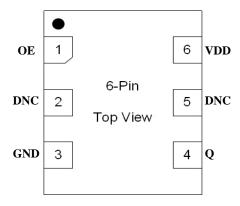
October 11, 2017 MX555AB1-1488 Revision 1.0 tcghelp@microchip.com

Ordering Information

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX555ABH25M0000	MX555A	BH0250	Tube	6-Pin 5mm x 3.2mm LGA
MX555ABH25M0000-TR	MX555A	BH0250	Tape and Reel	6-Pin 5mm x 3.2mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

Pin Configuration



Pin Description

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	OE	I, SE	LVCMOS	Output Enable, disables output to tri-state, 1 = Disabled, 0 = Enabled, 50k Ohms Pull-Down
2	DNC			Make no connection, leave floating.
3	GND	PWR		Power Supply Ground
4, 5	Q, DNC	O, SE	LVCMOS	Clock Output Frequency = 25MHz
6	VDD	PWR		Power Supply

Environmental Specifications

Thermal Shock	MIL-STD-883, Method 1011, Condition A		
Moisture Resistance	MIL-STD-883, Method 1004		
Mechanical Shock	MIL-STD-883, Method 2002, Condition C		
Mechanical Vibration	MIL-STD-883, Method 2007, Condition B		
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)		
Hazardous Substance	Pb-Free / RoHS / Green Compliant		
Solderability	JESD22-B102-D Method 2 (Preconditioning E)		
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D		
Gross Leak	MIL-STD-883, Method 1014, Condition C		
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s		
Solvent Resistance	MIL-STD-202, Method 215		

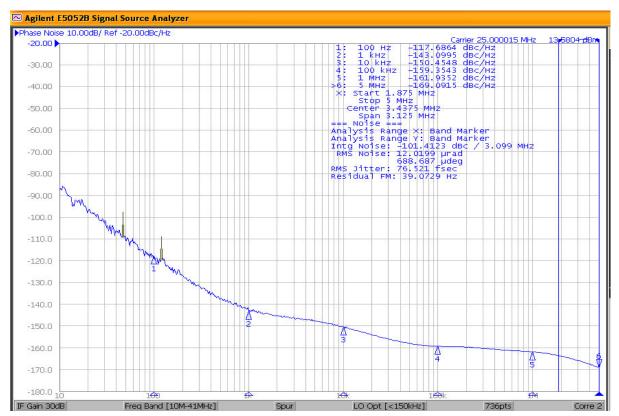


Figure 1. LVCMOS Output 25MHz 1.875MHz-5MHz 77fs

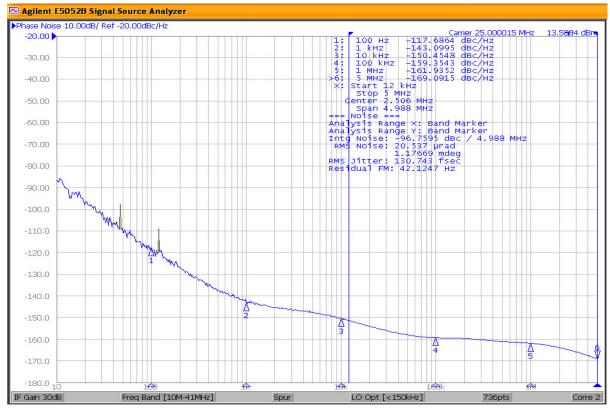
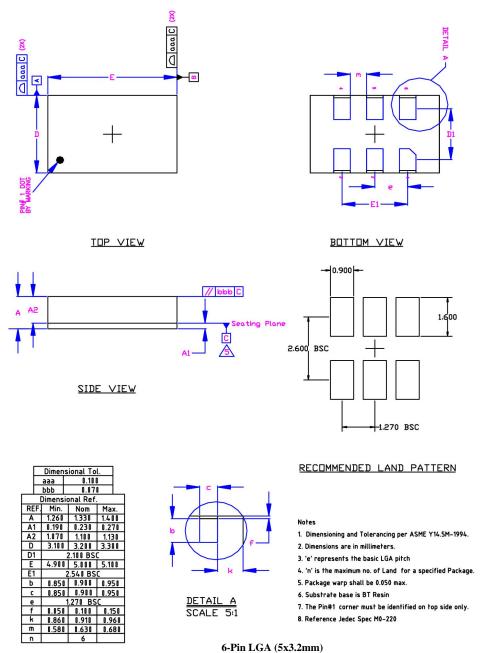


Figure 2. LVCMOS Output 25MHz 12kHz-5MHz 131fs

Package Information and Recommended Land Pattern for 6-Pin LGA³



Note:

3. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.

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